

Preface

The Organizing Committee warmly welcomes all participants of the 8th International Conference on Mechanical Engineering, Materials Science and Civil Engineering (ICMEMSCE2020), that was held on November 23-24, 2020 (virtual), Bangkok, Thailand.

The aim of ICMEMSCE2020 was to bring together researchers, scientists, engineers, and scholar students to exchange and share their experiences, new ideas, and research results about all aspects of materials science in Education, and discuss the practical challenges encountered and the solutions adopted.

After the peer-review process, the submitted papers were selected on the basis of originality, significance, and clarity for the purpose of the conference. The selected papers and additional late-breaking contributions to be presented as lectures will make an exciting technical program. The conference program is extremely rich, featuring high-impact presentation. We hope that the conference results constituted significant contribution to the knowledge in these up to date scientific field.

On behalf of the organizing committee, the editor would like to acknowledge the technical comments from the reviewers and thank all of the authors for their contributions to this proceeding book.

With our warmest regards,

Jing Wei Zhao
Conference Organizing Chair
December 31th 2020

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